

DEC 0 9 2002

## AMENDMENT TRANSMITTAL LETTER (Large Entity)

Applicant(s): Seungbae Park et al

Docket No.

EN999048D

Serial No.

10/038,264

Filing Date

1/3/02

Examiner

Ernesto Garcia

Group Art Unit

3679

Invention: SOLDER INTERCONNECT TECHNIQUE

TO THE ASSISTANT COMMISSIONER FOR PATENTS:

Transmitted herewith is an amendment in the above-identified application.

The fee has been calculated and is transmitted as shown below.

## CLAIMS AS AMENDED

	CLAIMS REMAINING AFTER AMENDMENT	HIGHEST # PREV. PAID FOR	NUMBER EXTRA CLAIMS PRESENT	RATE	ADDITIONAL FEE
TOTAL CLAIMS	4 -	20 =	0 x	\$18.00	\$0.00
INDEP. CLAIMS	3 -	5 =	0 x	\$84.00	\$0.00
Multiple Dependent Claims (check if applicable) <input type="checkbox"/>					\$0.00
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT					\$0.00

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

*1/Ltr: an corr  
20  
12-13m*

In re patent application of: ) Art Unit: 3679'  
Seungbae Park et al ) Examiner: Ernesto Garcia  
Serial No.: 10/038,264 ) Date: December 2, 2002  
Filed: January 3, 2002 ) Atty. Docket No.: EN999048D  
For: SOLDER INTERCONNECT )  
TECHNIQUES )

LETTER TO THE OFFICIAL DRAFTSMAN

Honorable Commissioner of Patents and Trademarks

Washington, DC 20231

S I R:

Please enter the following revised formal drawings,  
Figure 2, Figure 2a, and Figure 4, submitted herewith.  
Reference numeral 15 has been added to identify the  
intermetallic boundary in accordance with the Examiner's  
remarks.

*not accepted  
qj.*

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Respectfully submitted,



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